#### 查询SN54AHC123A供应商

## <u>捷多邦, 专业PCBSN54AH0123A</u> DUAL RETRIGGERABLE MONOSTABLE MULTIVIBRATORS

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Operating Range 2-V to 5.5-V V<sub>CC</sub>

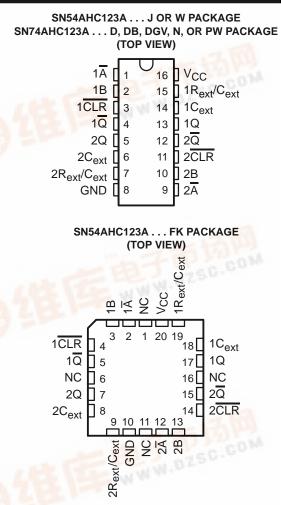
 Schmitt-Trigger Circuitry On A, B, and CLR Inputs for Slow Input Transition Rates

- Edge Triggered From Active-High or Active-Low Gated Logic Inputs
- Retriggerable for Very Long Output Pulses
- Overriding Clear Terminates Output Pulse
- Glitch-Free Power-Up Reset On Outputs
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
  - ESD Protection Exceeds JESD 22
    - 2000-V Human-Body Model (A114-A)
    - 200-V Machine Model (A115-A)
    - 1000-V Charged-Device Model (C101)

#### description/ordering information

The 'AHC123A devices are dual retriggerable monostable multivibrators designed for 2-V to 5.5-V  $V_{CC}$  operation.

These edge-triggered multivibrators feature output pulse-duration control by three methods. In the first method, the  $\overline{A}$  input is low, and the B input goes high. In the second method, the B input is high, and the  $\overline{A}$  input goes low. In the third method, the  $\overline{A}$  input is low, the B input is high, and the clear ( $\overline{CLR}$ ) input goes high.



NC – No internal connection

TA	PACK	AGET	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	SN74AHC123AN	SN74AHC123AN
–40°C to 85°C	SOIC – D	Tube	SN74AHC123AD	AHC123A
	3010 - 0	Tape and reel	SN74AHC123ADR	ANCIZSA
-40 C 10 85 C	SSOP – DB	Tape and reel	SN74AHC123ADBR	HA123A
	TSSOP – PW	Tape and reel	SN74AHC123APWR	HA123A
	TVSOP – DGV	Tape and reel	SN74AHC123ADGVR	HA123A
	CDIP – J	Tube	SNJ54AHC123AJ	SNJ54AHC123AJ
–55°C to 125°C	CFP – W	Tube	SNJ54AHC123AW	SNJ54AHC123AW
	LCCC – FK	Tube	SNJ54AHC123AFK	SNJ54AHC123AFK

#### ORDERING INFORMATION

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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FODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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### description/ordering information (continued)

The output pulse duration is programmed by selecting external resistance and capacitance values. The external timing capacitor must be connected between  $C_{ext}$  and  $R_{ext}/C_{ext}$  (positive) and an external resistor connected between  $R_{ext}/C_{ext}$  and  $V_{CC}$ . To obtain variable pulse durations, connect an external variable resistance between  $R_{ext}/C_{ext}$  and  $V_{CC}$ . The output pulse duration also can be reduced by taking  $\overline{CLR}$  low.

Pulse triggering occurs at a particular voltage level and is not directly related to the transition time of the input pulse. The  $\overline{A}$ , B, and  $\overline{CLR}$  inputs have Schmitt triggers with sufficient hysteresis to handle slow input transition rates with jitter-free triggering at the outputs.

Once triggered, the basic pulse duration can be extended by retriggering the gated low-level-active  $(\overline{A})$  or high-level-active (B) input. Pulse duration can be reduced by taking  $\overline{CLR}$  low.  $\overline{CLR}$  input can be used to override  $\overline{A}$  or B inputs. The input/output timing diagram illustrates pulse control by retriggering the inputs and early clearing.

The variance in output pulse duration from device to device typically is less than  $\pm 0.5\%$  for given external timing components. An example of this distribution for the 'AHC123A is shown in Figure 10. Variations in output pulse duration versus supply voltage and temperature are shown in Figure 6.

During power up, Q outputs are in the low state, and  $\overline{Q}$  outputs are in the high state. The outputs are glitch free, without applying a reset pulse.

For additional application information on multivibrators, see the application report *Designing With the SN74AHC123A and SN74AHCT123A*, literature number SCLA014.

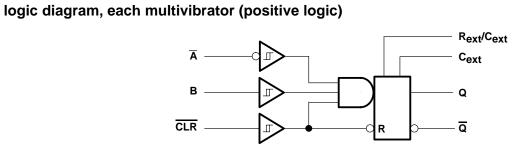
	(cacil iii	unuvn	Jiatory			
I	NPUTS	OUTPUTS				
CLR	Ā	в	Q	Q		
L	Х	Х	L	Н		
х	Н	Х	L†	н†		
х	Х	L	L†	н†		
н	L	$\uparrow$	л	ប		
н	Ļ	н	л	U		
<b>↑</b>	L	н	л	ប		
† These	outputs	are	based	on the		

#### FUNCTION TABLE (each multivibrator)

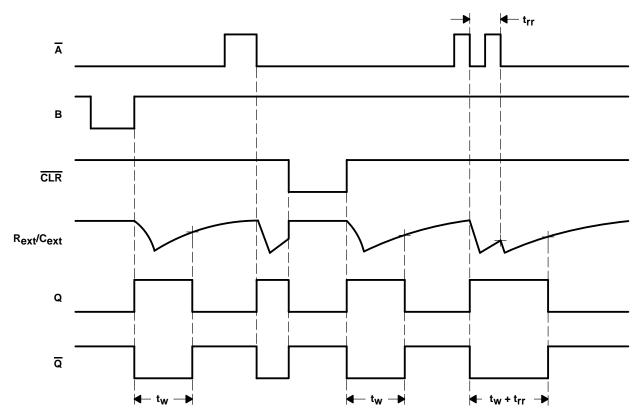
<sup>†</sup>These outputs are based on the assumption that the indicated steady-state conditions at the A and B inputs have been set up long enough to complete any pulse started before the setup.



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### input/output timing diagram





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### absolute maximum ratings over operating free-air temperature (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub> (see Note 1)		–0.5 V to 7 V
Input voltage range, V <sub>1</sub> (see Note 2)		
		-0.5 V to V <sub>CC</sub> + 0.5 V
Output voltage range in power-off state, V	O (see Note 1)	–0.5 V to 7 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	-	
Output clamp current, $I_{OK}$ (V <sub>O</sub> < 0 or V <sub>O</sub> >	> V <sub>CC</sub> )	±20 mA
		±25 mA
		±50 mA
		120°C/W
	PW package	108°C/W
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values are with respect to the network ground terminal.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

3. The package thermal impedance is calculated in accordance with JESD 51-7.

#### recommended operating conditions (see Note 4)

			SN54AH	C123A	SN74AH	C123A	
			MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage		2	5.5	2	5.5	V
		$V_{CC} = 2 V$	1.5		1.5		
$V_{\text{IH}}$	High-level input voltage	$V_{CC} = 3 V$	2.1		2.1		V
		$V_{CC} = 5.5 V$	3.85		3.85		
		$V_{CC} = 2 V$		0.5		0.5	
VIL	Low-level input voltage	$V_{CC} = 3 V$		0.9		0.9	V
		$V_{CC} = 5.5 V$		1.65		1.65	
VI	Input voltage		0	5.5	0	5.5	V
VO	Output voltage		0	VCC	0	VCC	V
		$V_{CC} = 2 V$		-50		-50	μA
ЮН	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4		-4	~ ^
		$V_{CC}$ = 5 V ± 0.5 V		-8		-8	mA
		$V_{CC} = 2 V$		50		50	μA
IOL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4		4	mA
		$V_{CC}$ = 5 V ± 0.5 V		8		8	mA
D	External timing registeres	$V_{CC} = 2 V$	5k		5k		Ω
R <sub>ext</sub>	External timing resistance	V <sub>CC</sub> > 3 V	1k		1k		52
$\Delta t / \Delta V_{CC}$	Power-up ramp rate		1		1		ms/V
т <sub>А</sub>	Operating free-air temperature		-55	125	-40	85	°C

NOTE 4: Unused R<sub>ext</sub>/C<sub>ext</sub> terminals should be left unconnected. All remaining unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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	DAMETER	TEST CONDITIONS	м	Т	ן = 25°C	)	SN54AH	C123A	SN74AH	C123A	UNIT	
P/	ARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
			2 V	1.9	2		1.9		1.9			
		I <sub>OH</sub> = -50 μA	3 V	2.9	3		2.9		2.9			
۷он			4.5 V	4.4	4.5		4.4		4.4		V	
		$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		2.48			
		I <sub>OH</sub> = -8 mA	4.5 V	3.94			3.8		3.8			
			2 V			0.1		0.1		0.1		
		I <sub>OL</sub> = 50 μA	3 V			0.1		0.1		0.1		
VOL			4.5 V			0.1		0.1		0.1	V	
		$I_{OL} = 4 \text{ mA}$	3 V			0.36		0.5		0.44		
		I <sub>OL</sub> = 8 mA	4.5 V			0.36		0.5		0.44		
I.	R <sub>ext</sub> /C <sub>ext</sub> †	$V_I = V_{CC} \text{ or } GND$	5.5 V			±0.25		±2.5		±2.5	A	
lj –	A, B, and CLR	$V_{I} = V_{CC} \text{ or } GND$	0 V to 5.5 V			±0.1		±1*		±1	μA	
ICC	Quiescent	$V_I = V_{CC} \text{ or } GND,  I_O = 0$	5.5 V			4		40		40	μA	
			3 V		160	250		280		280		
ICC	CC Active state (per circuit)		4.5 V		280	500		650		650	μA	
		Nextr Cext - 0.5 VCC	5.5 V		360	750		975		975		
Ci	-	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V		1.9	10				10	pF	

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

\* On products compliant to MIL-PRF-38535, this parameter is not production tested at  $V_{CC} = 0 V$ .

<sup>†</sup> This test is performed with the terminal in the off-state condition.

## timing requirements over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

			TEST CONDITIONS	T <sub>A</sub> = 25°C			SN54AHC123A		SN74AHC123A		UNIT
			TEST CONDITIONS	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
•	Pulse	CLR		5			5		5		ns
١w	duration	A or B trigger		5			5		5		115
	Dulas natria	n on time o	$R_{ext} = 1 \text{ k}\Omega$ , $C_{ext} = 100 \text{ pF}$	‡	76		‡		‡		ns
t <sub>rr</sub>	Pulse retrig	gertime	$R_{ext} = 1 \text{ k}\Omega, C_{ext} = 0.01 \mu\text{F}$	‡	1.8		‡		‡		μs

<sup>‡</sup> See retriggering data in the *application information* section.

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

	TES		TEST CONDITIONS	T <sub>A</sub> = 25°C			SN54AHC123A		SN74AHC123A		UNIT
			TEST CONDITIONS	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	Pulse	CLR		5			5		5		20
tw	duration	A or B trigger		5			5		5		ns
	Dulas natriau		$R_{ext} = 1 \text{ k}\Omega, C_{ext} = 100 \text{ pF}$	‡	59		‡		‡		ns
۲r	t <sub>rr</sub> Pulse retrigger time		$R_{ext} = 1 \text{ k}\Omega, C_{ext} = 0.01 \mu\text{F}$	‡	1.5		‡		‡		μS

<sup>‡</sup> See retriggering data in the *application information* section.



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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

				-	_						
	FROM	то	TEST	Т	ן = 25°C	;	SN54AH	C123A	SN74AH	C123A	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CONDITIONS	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
<sup>t</sup> PLH	A or B	Q or $\overline{Q}$	C <sub>L</sub> = 15 pF		9.5*	20.6*	1*	24*	1	24	ns
<sup>t</sup> PHL	A or B	Q or Q	Ο <u>Γ</u> = 13 μ-		10.2*	20.6*	1*	24*	1	24	115
<sup>t</sup> PLH	CLR	Q or Q	C <sub>L</sub> = 15 pF		7.5*	15.8*	1*	18.5*	1	18.5	ns
<sup>t</sup> PHL	CLR		0 <u>[</u> = 13 pi		9.3*	15.8*	1*	18.5*	1	18.5	115
<sup>t</sup> PLH	CLD trigger	Q or Q	C <sub>L</sub> = 15 pF		10*	22.4*	1*	26*	1	26	ns
<sup>t</sup> PHL	CLR trigger		0[ = 10 pi		10.6*	22.4*	1*	26*	1	26	115
<sup>t</sup> PLH	A or B	Q or Q	C <sub>L</sub> = 50 pF		10.5	24.1	1	27.5	1	27.5	ns
<sup>t</sup> PHL	AOLP	QOIQ	0L = 30 pi		11.8	24.1	1	27.5	1	27.5	115
<sup>t</sup> PLH		0 0	C <sub>L</sub> = 50 pF		8.9	19.3	1	22	1	22	ns
<sup>t</sup> PHL	CLR	Q or $\overline{Q}$	0L = 30 pr		10.5	19.3	1	22	1	22	115
<sup>t</sup> PLH		Q or Q	C <sub>L</sub> = 50 pF		11	25.9	1	29.5	1	29.5	ns
<sup>t</sup> PHL	CLR trigger	Q or Q	CL = 30 pr		12.3	25.9	1	29.5	1	29.5	115
			$C_L = 50 \text{ pF},$ $C_{ext} = 28 \text{ pF},$ $R_{ext} = 2 \text{ k}\Omega$		182	240		300		300	ns
<sub>tw</sub> †		Q or $\overline{Q}$	$\begin{array}{l} C_L = 50 \text{ pF},\\ C_{ext} = 0.01 \mu\text{F},\\ R_{ext} = 10 k\Omega \end{array}$	90	100	110	90	110	90	110	μs
			$\begin{array}{l} C_L = 50 \text{ pF},\\ C_{ext} = 0.1 \mu\text{F},\\ R_{ext} = 10 k\Omega \end{array}$	0.9	1	1.1	0.9	1.1	0.9	1.1	ms
$\Delta t_w^{\ddagger}$					±1						%

\* On products compliant to MIL-PRF-38535, this parameter is not production tested. †  $t_W$  = Pulse duration at Q and  $\overline{Q}$  outputs ‡  $\Delta t_W$  = Output pulse-duration variation (Q and  $\overline{Q}$ ) between circuits in same package

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PARAMETER	FROM	то	TEST			SN54AH	C123A	SN74AH	C123A	UNIT	
FARAMETER	(NPUT)	(OUTPUT)	CONDITIONS	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
<sup>t</sup> PLH	<del>.</del>	0	C <sub>L</sub> = 15 pF		6.5*	12*	1*	14*	1	14	
<sup>t</sup> PHL	A or B	Q or $\overline{Q}$	CL = 15 pr		7.1*	12*	1*	14*	1	14	ns
<sup>t</sup> PLH	CLR	Q or $\overline{Q}$	C <sub>L</sub> = 15 pF		5.3*	9.4*	1*	11*	1	11	ns
<sup>t</sup> PHL	CLR	QorQ	CL = 13 pr		6.5*	9.4*	1*	11*	1	11	115
<sup>t</sup> PLH		0 0	C <sub>L</sub> = 15 pF		6.9*	12.9*	1*	15*	1	15	ns
<sup>t</sup> PHL	CLR trigger	Q or $\overline{Q}$	0 <u>[</u> = 10 pi		7.4*	12.9*	1*	15*	1	15	115
<sup>t</sup> PLH	A or B	Q or $\overline{Q}$	C <sub>L</sub> = 50 pF		7.3	14	1	16	1	16	ns
<sup>t</sup> PHL	A of B	QorQ	CL = 30 pr		8.3	14	1	16	1	16	115
<sup>t</sup> PLH		0 5	C <sub>L</sub> = 50 pF		6.3	11.4	1	13	1	13	ns
<sup>t</sup> PHL	CLR	Q or $\overline{Q}$	CL = 50 pr		7.4	11.4	1	13	1	13	115
<sup>t</sup> PLH		0 5	C <sub>L</sub> = 50 pF		7.6	14.9	1	17	1	17	ns
<sup>t</sup> PHL	CLR trigger	Q or $\overline{Q}$	CL = 50 pr		8.7	14.9	1	17	1	17	115
			$C_L = 50 \text{ pF},$ $C_{ext} = 28 \text{ pF},$ $R_{ext} = 2  k\Omega$		167	200		240		240	ns
<sub>tw</sub> †		Q or $\overline{Q}$	$\begin{array}{l} C_L = 50 \text{ pF},\\ C_{ext} = 0.01 \mu\text{F},\\ R_{ext} = 10 k\Omega \end{array}$	90	100	110	90	110	90	110	μs
			$\begin{array}{l} C_L = 50 \text{ pF},\\ C_{ext} = 0.1 \mu\text{F},\\ R_{ext} = 10 k\Omega \end{array}$	0.9	1	1.1	0.9	1.1	0.9	1.1	ms
$\Delta t_W^{\ddagger}$					±1						%

## switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

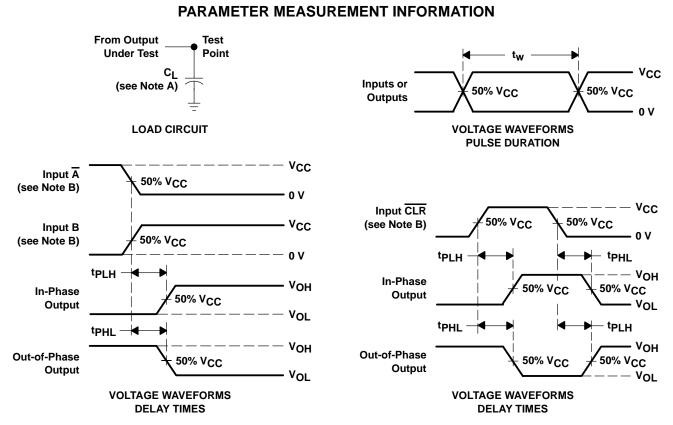
\* On products compliant to MIL-PRF-38535, this parameter is not production tested. †  $t_W$  = Pulse duration at Q and  $\overline{Q}$  outputs ‡  $\Delta t_W$  = Output pulse-duration variation (Q and  $\overline{Q}$ ) between circuits in same package

## operating characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load	29	pF



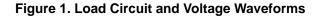
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NOTES: A. CL includes probe and jig capacitance.

B. All input pulses are supplied by generators having the following characteristics:  $Z_0 = 50 \Omega$ ,  $t_r = 3 ns$ ,  $t_f = 3 ns$ .

C. The outputs are measured one at a time with one input transition per measurement.





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#### **APPLICATION INFORMATION**

#### caution in use

To prevent malfunctions due to noise, connect a high-frequency capacitor between  $V_{CC}$  and GND, and keep the wiring between the external components and  $C_{ext}$  and  $R_{ext}/C_{ext}$  terminals as short as possible.

#### power-down considerations

Large values of C<sub>ext</sub> can cause problems when powering down the 'AHC123A devices because of the amount of energy stored in the capacitor. When a system containing this device is powered down, the capacitor can discharge from V<sub>CC</sub> through the protection diodes at pin 2 or pin 14. Current through the input protection diodes must be limited to 30 mA; therefore, the turn-off time of the V<sub>CC</sub> power supply must not be faster than  $t = V_{CC} \times C_{ext}/30$  mA. For example, if V<sub>CC</sub> = 5 V and C<sub>ext</sub> = 15 pF, the V<sub>CC</sub> supply must turn off no faster than  $t = (5 \text{ V}) \times (15 \text{ pF})/30$  mA = 2.5 ns. Usually, this is not a problem because power supplies are heavily filtered and cannot discharge at this rate. When a more rapid decrease of V<sub>CC</sub> to zero occurs, the 'AHC123A devices can sustain damage. To avoid this possibility, use external clamping diodes.

#### output pulse duration

The output pulse duration,  $t_w$ , is determined primarily by the values of the external capacitance (C<sub>T</sub>) and timing resistance (R<sub>T</sub>). The timing components are connected as shown in Figure 2.

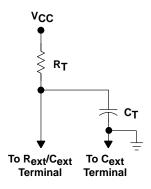


Figure 2. Timing-Component Connections

The pulse duration is given by:

$$t_w = K \times R_T \times C_T$$

if  $C_T$  is  $\geq 1000 \text{ pF}$ , K = 1.0 or

if  $C_T$  is <1000 pF, K can be determined from Figure 5

where:

t<sub>w</sub> = pulse duration in ns

- $R_T$  = external timing resistance in  $k\Omega$
- C<sub>T</sub> = external capacitance in pF
- K = multiplier factor

Equation 1 and Figure 3 can be used to determine values for pulse duration, external resistance, and external capacitance.



(1)

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### **APPLICATION INFORMATION**

#### retriggering data

The minimum input retriggering time ( $t_{MIR}$ ) is the minimum time required after the initial signal before retriggering the input. After  $t_{MIR}$ , the device retriggers the output. Experimentally, it also can be shown that to retrigger the output pulse, the two adjacent input signals should be  $t_{MIR}$  apart, where  $t_{MIR} = 0.30 \times t_w$ . The retrigger pulse duration is calculated as shown in Figure 3.

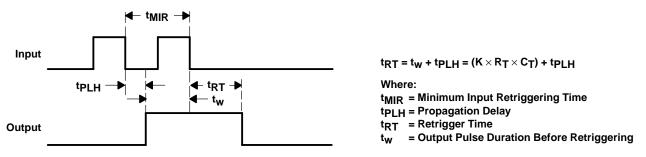
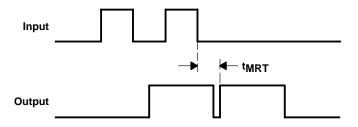


Figure 3. Retrigger Pulse Duration

The minimum value from the end of the input pulse to the beginning of the retriggered output should be approximately 15 ns to ensure a retriggered output (see Figure 4).

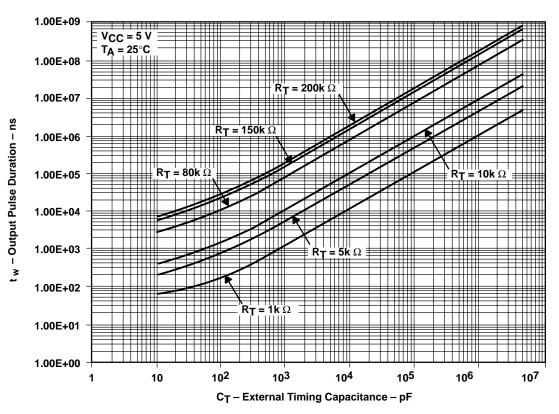


 $t_{MRT}$  = Minimum Time Between the End of the Second Input Pulse and the Beginning of the Retriggered Output  $t_{MRT}$  = 15 ns

#### Figure 4. Input/Output Requirements



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**APPLICATION INFORMATION<sup>†</sup>** 

Figure 5. Output Pulse Duration vs External Timing Capacitance

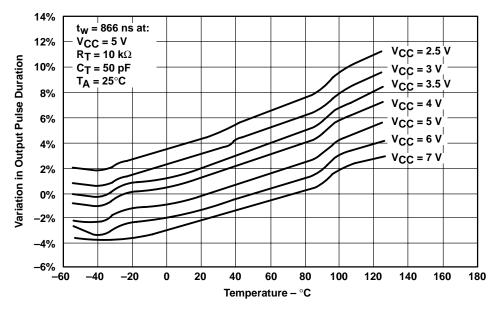
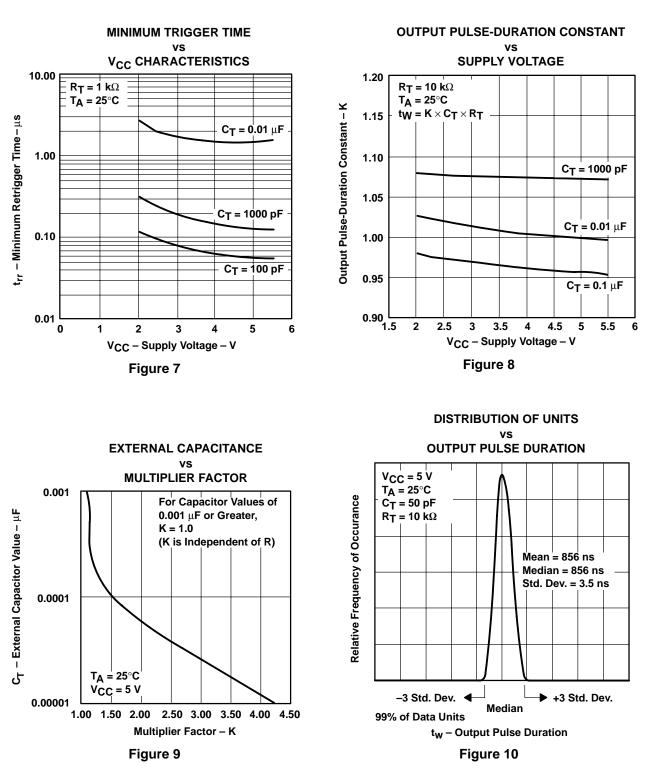


Figure 6. Variations in Output Pulse Duration vs Temperature

<sup>†</sup>Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.



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**APPLICATION INFORMATION<sup>†</sup>** 

<sup>†</sup> Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.





## PACKAGE OPTION ADDENDUM

26-Sep-2005

### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-9860801Q2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9860801QEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
5962-9860801QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SN74AHC123AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123ADBR	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123ADBRE4	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123ADE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123ADG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123ADGVR	ACTIVE	TVSOP	DGV	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123ADGVRE4	ACTIVE	TVSOP	DGV	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123ADRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123ADRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AHC123ANE4	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AHC123APWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC123APWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54AHC123AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54AHC123AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54AHC123AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)



## PACKAGE OPTION ADDENDUM

26-Sep-2005

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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### J (R-GDIP-T\*\*) 14 LEADS SHOWN

#### PINS \*\* 14 16 20 18 DIM 0.300 0.300 0.300 0.300 В Α (7,62) (7,62) (7,62) (7,62) BSC BSC BSC BSC 14 8 0.785 .840 0.960 1.060 B MAX (19, 94)(21, 34)(24, 38)(26, 92)B MIN С 0.300 0.300 0.310 0.300 C MAX (7, 62)(7, 62)(7, 87)(7, 62)7 0.245 0.245 0.220 0.245 0.065 (1,65) C MIN (6, 22)(6,22) (5, 59)(6,22) 0.045 (1,14) 0.060 (1,52) ← 0.005 (0,13) MIN Α 0.015 (0,38) 0.200 (5,08) MAX Seating Plane 0.130 (3,30) MIN 0.026 (0,66) 0.014 (0,36) 0'-15' 0.100 (2,54) 0.014 (0,36) 0.008 (0,20) 4040083/F 03/03

CERAMIC DUAL IN-LINE PACKAGE

NOTES: A. All linear dimensions are in inches (millimeters).

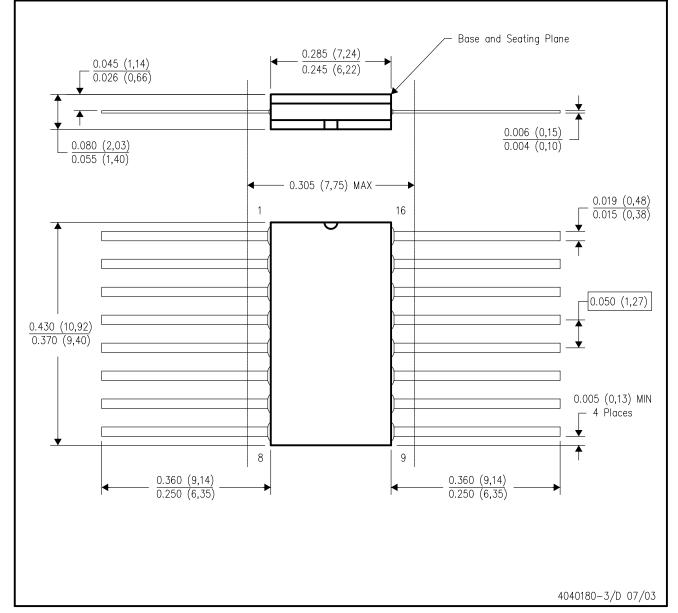
B. This drawing is subject to change without notice.

- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.

E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



NOTES:

: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC

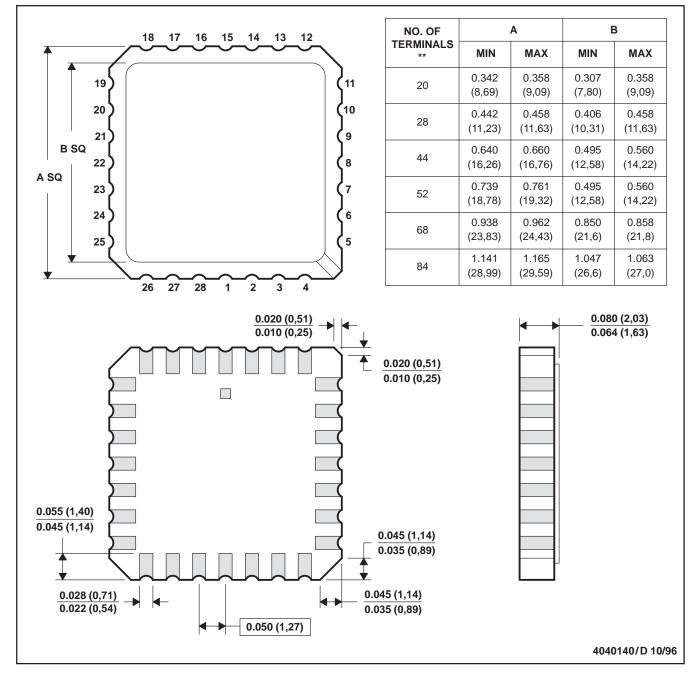


## **MECHANICAL DATA**

MLCC006B - OCTOBER 1996

#### LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N\*\*) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

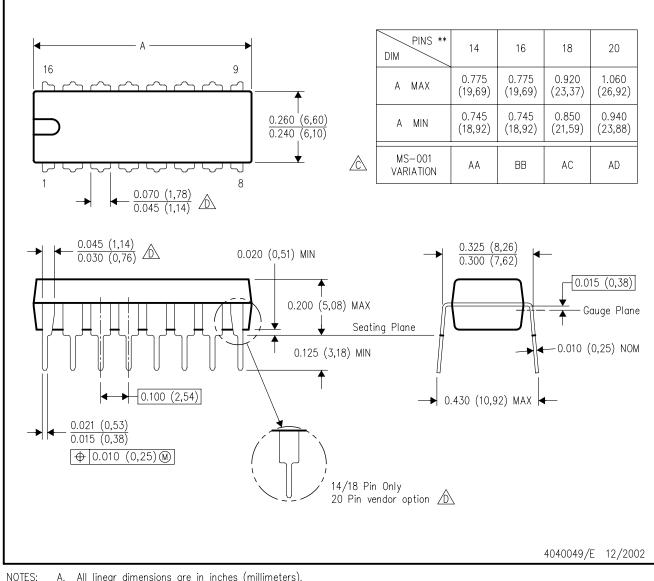
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



## N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

🖄 Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

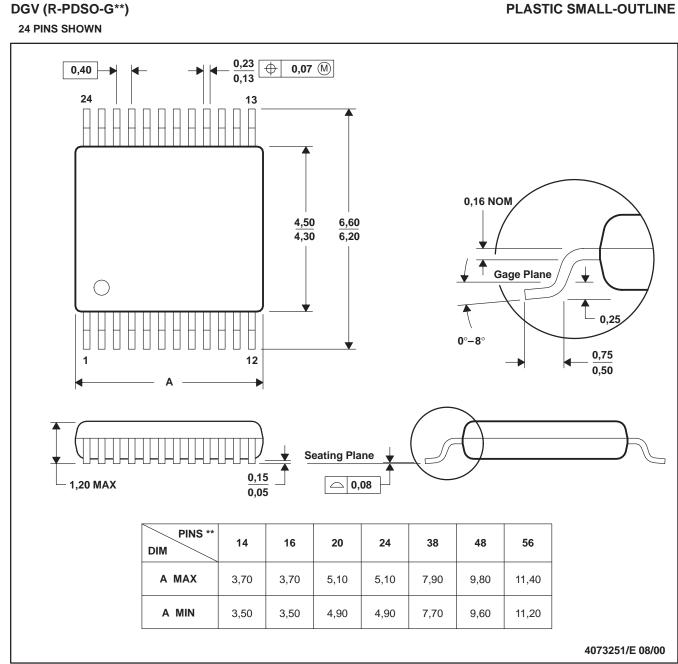
The 20 pin end lead shoulder width is a vendor option, either half or full width.



## **MECHANICAL DATA**

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

#### PLASTIC SMALL-OUTLINE



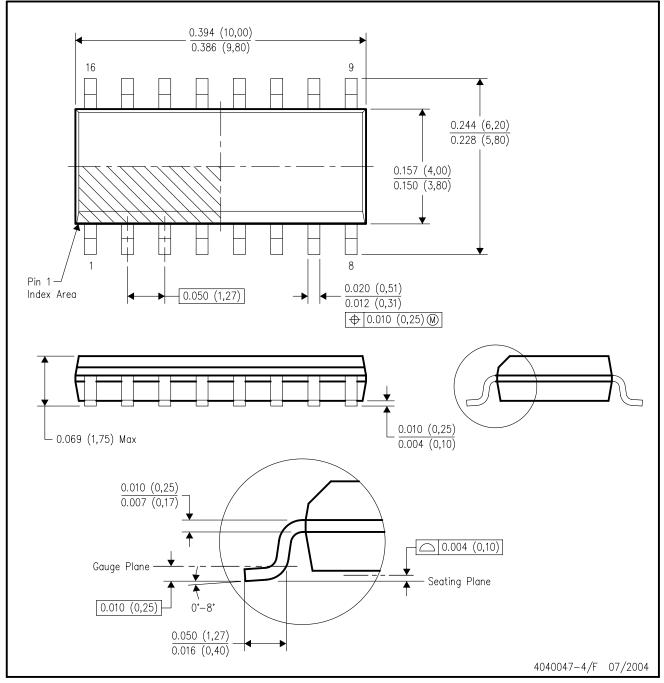
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153
  - 14/16/20/56 Pins MO-194



## D (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

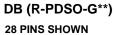
D. Falls within JEDEC MS-012 variation AC.

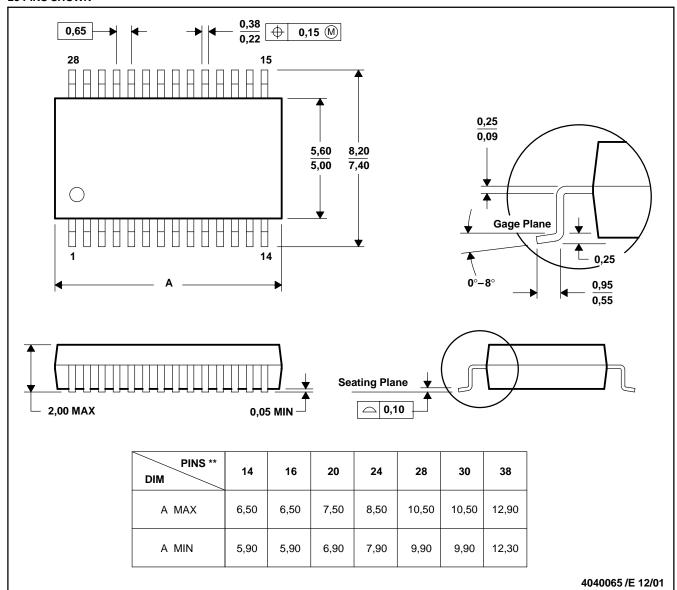


## **MECHANICAL DATA**

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

#### PLASTIC SMALL-OUTLINE





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150



## **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

#### PLASTIC SMALL-OUTLINE PACKAGE





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153



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